12-18-2003

RECORDATION FORM (PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record use attached original documents or copy thereof.

Name of conveying party(ies): (in counterpart)	2. Name and address of receiving party(ies):
	2. A sum and address of recovering party (res).
(1) Anwar ALI	Name: LSI Logic Corporation
(2) Tauman T. LAU	Street Address: 1621 Barber Lane
(3) Kalyan DODDAPANENI	City: Milpitas State: CA Zip: 95035
Additional name(s) of conveying party(ies) attached? ☐ Yes ■ No.	Additional name(s) and address(es) attached? ☐ Yes ■ No.
3. Nature of conveyance: Assignment Ex	(2) December 9, 2003 (3) December 9, 2003
4. Application number(s) or patent number(s): If this document is being filed together with a new application process. December 9, 2003, December 9, 2003, and December 9, 2003	
A. Patent Application No.(s)	B. Patent No.(s)
Additional numb	ers attached? □Yes ■No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: One
Name: Sandeep Jaggi LSI Logic Corporation	7. Total fee (37 CFR 3.41)
Address: 1621 Barber Lane, M/S D-106 Milpitas, CA 95035	Authorized to be charged to deposit account 8. Deposit account number: 12-2252 (LSI Logic Corporation) (Attach duplicate copy of this page if paying by deposit account)
9. Statement and signature. To the best of my knowledge and belief, the foregoing original document.	information is true and correct and any attached copy is a true copy of the
Stephen G. Sullivan	December 9, 2003
Name of Person Signing 7/2003 DBYRNE 00000060 122252 10732395	Signature Date
C:8021 40.00 DA	

Total number of pages including cover sheet, attachments, and documents: 2

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the undersigned, Anwar ALI, Tauman T. LAU and Kalyan DODDAPANENI, do hereby sell, assign, and transfer to: LSI Logic Corporation, a corporation existing under the laws of the state of Delaware, having a principal place of business at 1621 Barber Lane, Milpitas, CA 95035 ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for the United States Letters Patent,

	which has been executed by the undersigned concurrently herewith,
	which was filed on and assigned Serial No:
and is entit	led:

CELL-BASED METHOD FOR CREATING SLOTTED METAL IN SEMICONDUCTOR DESIGNS

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Signed:

Name: Poec 2003

Date: 90Ec 2003

Name: Date: 12/05/03

Name: Lauman T. LAU

Name: Lauman Dodd, Date: 12/09/63

RECORDED: 12/09/2003

PATENT REEL: 014792 FRAME: 0146